Advanced Micro and Nanofabrication Technologies

Engineering Physics – Ingegneria Fisica - Cod. 055559

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Lecture 3 Surfaces

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DIPARTIMENTO DI FISICA





Outline of the course

➤ Where we will grow? Vacuum → Vacuum technology: pressure, gas transport, vacuum systems

> On what we will grow? Surfaces Surface properties, nucleation, film growth modes

➤ Which kind of films we will grow? Epitaxy

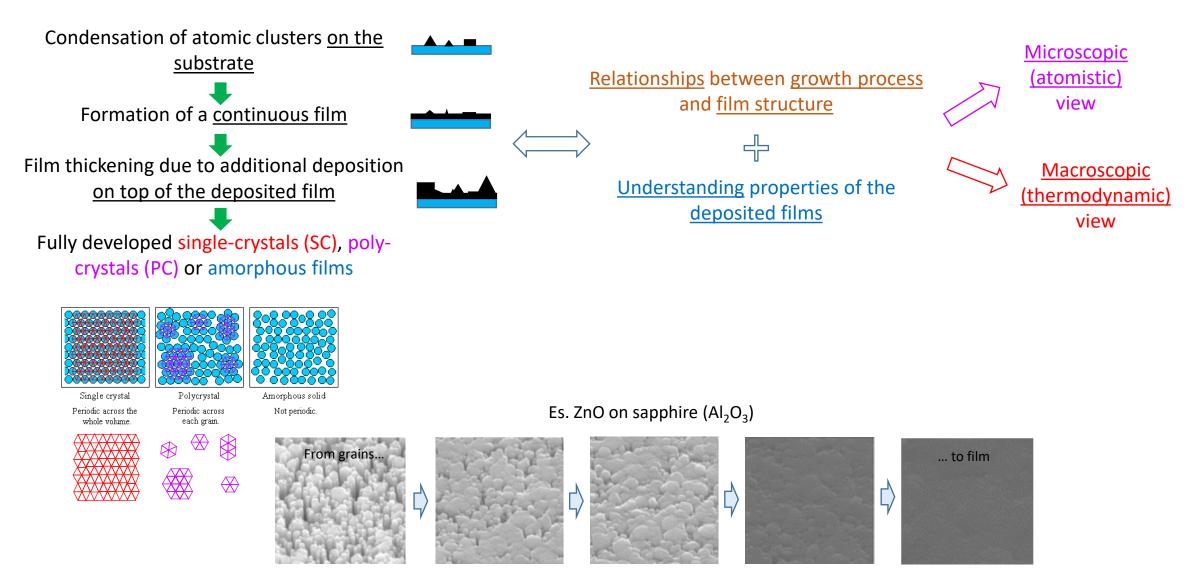
Physical techniques
 Sputtering
 Chemical techniques

How we will check the growth? Characterization

Reference for this lecture: M. Ohring, Materials Science of Thin films, Academic Press, Chapters 1 and 7

Why surfaces are important?

How growth takes place?



What happens on surfaces?

Electronics properties

Structural properties

Different from bulk because of **broken** translational simmetry!

Z V × X

the crystal is infinite along x and y, but finite along z → a surface is created with properties different from bulk

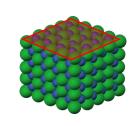
Adsorption effects
How the surface adsorption and desorption energies of atoms depositing on the surface influence surface coverage?

NOTE: this description is based on an atomistic description of the surface microscopic view

Structural properties

Hp: <u>clean</u> surface (*no contamination* by adsorbed gases and compounds) \implies

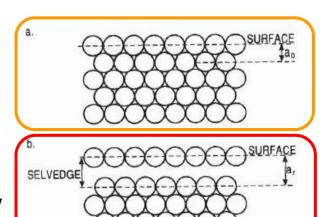
atomically <u>sharp interfacial</u>
<u>demarcation</u> between condensedphase and gas-phase atoms

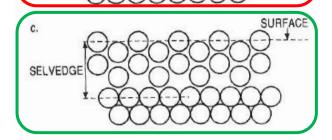


- Minimization of the overall electronic and bonding energies in the topmost atomic layers makes the surface crystallography *different* from that of the bulk.
- a) Bulk-like condition \Rightarrow not likely because of the loss of vertical simmetry leaving exposed bonds
- b) Atomic relaxation outward \Rightarrow *likely* if the absence of some bonding forces results in new equilibrium positions.

The symmetry *parallel* to the surface is *preserved*, but not the simmetry normal to the surface.

- c) Reconstructed layer \Rightarrow **possible** because surface atoms rearrange to minimize energy in a structure with *different simmetry* than bulk.
 - Many surface properties (chemical, electrical, optical, ...) can change.



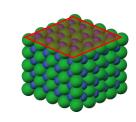


Schematic cross-sectional views of close-packed atomic positions at a solid surface: (a) Bulk exposed plan; (b) Atomic relaxation outward; (c) Reconstruction of outer layers (from M. Ohring, Materials Science of Thin films, Academic Press, Chapter 7)

Electronics properties

Hp: <u>clean</u> surface (*no contamination* by adsorbed gases and compounds) \implies

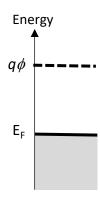
atomically <u>sharp</u> <u>interfacial</u> <u>demarcation</u> between condensedphase and <u>gas-phase</u> atoms



Near the surface the periodicity of the wave function in the bulk is broken ⇒ new electronic effects arise

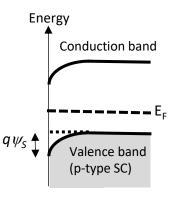
Metals:

- Surface states appear as predicted by the Schrödinger equation solutions for electrons in terminated periodic lattices
- The difference in the electron potential between surface states and bulk states is the Work Function (ϕ)
- $q\phi$ is the energy barrier that electrons with Fermi energy in the bulk must surmount for leaving the solid $(q\phi\sim2-5 \text{ eV})$, avoiding to be trapped by surface states



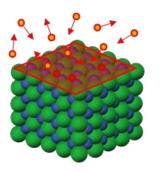
Semiconductors:

- Surface states are generated by the severed covalent bonds at the semiconductor surface
- When an electron or hole occupies a surface state, electrostatic fields originated from it penetrate the valence band (VB) and produce a variation of potential, that manifests as a band bending
- A nonzero electrical potential ψ_s exists at the surface due to band bending



Adsorption reactions

What happens when a surface is exposed to gas particles?



Surface adsorption – impinging atoms and molecules enter and interact within the transition region between the

gas phase and the surface. It is an exhotermic reaction.



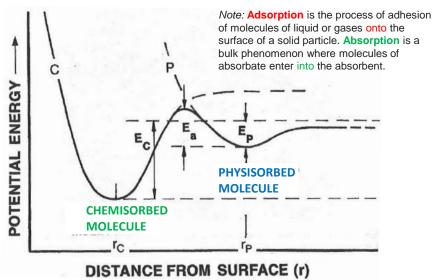
Physisorption (physical adsorption)

the particle is stretched or bent, but retains its identity; van der Waals forces bond it to the surface



Chemisorption (*chemical* adsorption)

the particle **changes its identity** through ionic or covalent bonding with surface atoms



Model of physisorption (P) and chemisorption (C) processes in terms of the interaction potential between adsorbate and surface vs. the distance from the surface (from M. Ohring, Materials Science of Thin films, Academic Press, Chapter 7)

In the following we will use

- composite energy of adsorption (integrated over all adsorption states) E_{ads} (<0)
- composite energy of desorption (integrated over all desorption states) E_{des} (>0)

Adsorption effects (1)

How the surface adsorption and desorption energies influence the film **growth**?

Consider a <u>vapor phase</u> containing adatoms at <u>partial pressure P</u>, that will <u>condensate</u> on a <u>substrate surface</u>

(<u>Note</u>: in the following, for simplicity we will call «substrate» the underlayer on which the film will be grown, either a true substrate or a film previously deposited, satisfying the hypotesis of cleanliness and sharpness)



$$\frac{d\theta}{dt} = k_{ads} P(1-\theta) - k_{des}\theta$$

(Note: k_{ads} and k_{des} do not have the same dimension)

where:

- \rightarrow θ = 0 means no coverage, θ = 1 means one monolayer (1 ML) coverage
- The first term is the <u>rate of adatoms coverage at the unoccupied surface</u> sites (1- θ); it is proportional to the partial pressure P and the absorption rate k_{ads} , that depends on the composite adsorption energy as:

$$k_{ads} \sim \exp\left(-\frac{E_{ads}}{k_B T}\right) \implies k_{ads}$$
 increases when $|E_{ads}|$ increases ($E_{ads}<0$ because adsorption is always exhotermic)

The second term is the <u>rate of adatoms desorption from the occupied surface sites</u> (θ); it is proportional to the desorption rate k_{des} , that depends on the composite desorption energy as:

Lecture#3: Surfaces

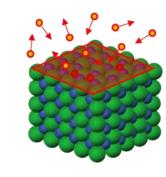
$$k_{des} \sim \exp\left(-\frac{E_{des}}{k_BT}\right) \implies k_{des}$$
 decreases when E_{des} increases (E_{des} >0 because desorption is always endhotermic)

Adsorption effects (2)

How the surface adsorption and desorption energies influence the film **growth**?

$$\frac{d\theta}{dt} = k_{ads}P(1-\theta) - k_{des}\theta \implies$$

$$\frac{d\theta}{dt} = k_{ads}P(1-\theta) - k_{des}\theta \implies \text{The solution is: } \\ \theta(t) = \frac{KP}{1+KP}[1-\exp(-k_{des}(1+KP)t)], \text{ with } K = \frac{k_{ads}}{k_{des}}$$

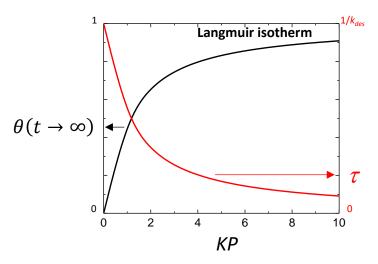


We define the time constant
$$\tau = [k_{des}(1 + KP)]^{-1}$$
 $\Rightarrow \theta(t) = \frac{KP}{1 + KP}[1 - \exp(-t/\tau)]$

Note that:

- If
$$t \rightarrow \infty$$
 (or $t >> \tau$) $\theta \approx \frac{KP}{1+KP}$ (Langmuir isotherm)

If KP >> 1 $\longrightarrow \{\theta(t) \approx 1 \text{ (the surface is covered by one monolayer of adatoms)}$ $\tau \approx [k_{des}KP]^{-1} = [k_{ads}P]^{-1} \to 0 \text{ (the process is very fast)}$



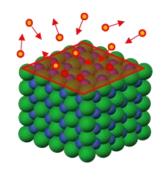
Note: $KP = \frac{k_{ads}}{k_{cos}}P >> 1$ means large P and/or large k_{ads} and/or small k_{des} , i.e. large $|E_{ads}|$ and/or large E_{des}

What «pressure» does mean?

$$\frac{d\theta}{dt} = k_{ads} P(1 - \theta) - k_{des} \theta$$

$$\theta(t \to \infty) \approx \frac{KP}{1 + KP}$$

$$\tau = [k_{des}(1 + KP)]^{-1}$$



• The pressure P which physical quantity does represent in a deposition process?



Evaporant material

Originating from a source

To be deposited on the surface



Local pressure (close to surface)

P determines the surface coverage, morphology, growth rate, ...



Residual gases

Originating from degassing, bad pumping etc.

NOT to be deposited on the surface



Global pressure (everywhere in the chamber)

P of residual gases as low as possible (<< P evaporant material)

From micro to macroscopic view

Electronics
Structure
Adsorption
(coverage vs. P)

Morphology etc.

atomistic details of the surface micros

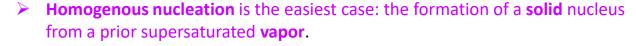
microscopic view

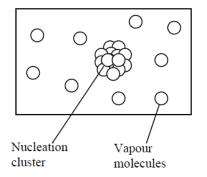




Thermodynamics aspects of nucleation ———— G (Gibbs free energy)

- Nucleation involves the creation a <u>new phase</u>, with generally <u>different</u> structure and/or composition (e.g. a solid phase), from a previously stable phase (e.g. a vapor phase) when critical boundaries between stable phases in equilibrium phase diagram are <u>crossed</u> (e.g. by decreasing the temperature, triggering the condensation process).
- Nucleation occurs during the very early stages of phase change, but have a strong influence on the grain structure that ultimately develops in a deposition process.
- Nucleation concerns the formation a single stable nucleus.





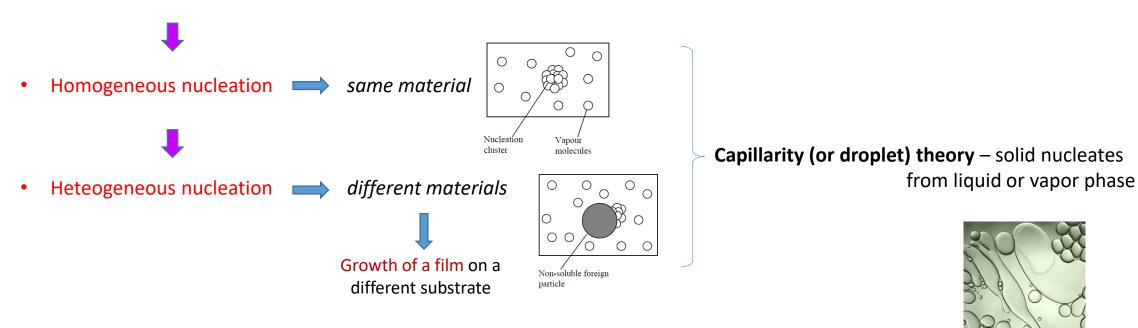
Questions:

- Under which conditions nuclei of deposited films are thermodynamically stable?
- What is the role of surface energy in film nucleation?
- ➤ How large nuclei are?
- What is the energy barrier to be surmounted in their formation?
- Which is the growth mode (island, planar, S-K)?
- ➤ Which is the effect of strain in volume or at interfaces?

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Thermodynamics

Surface energy associated to surface or interface creation



- Film growth modes islands vs. layer by layer
 - Strained layers morphological stability layer plus islands

Note: this description is based on a thermodynamic description of the nucleation process <u>macroscopic</u> view

Surface energies

Capillarity (or droplet) theory of homogeneous nucleation

- A solid (S) nucleates from a prior instable liquid (L) or vapor (V) phase by establishing a S-L or S-V interface.
- Interfacial (or surface) free energies γ are associated to the interface (or surface).
- They quantify the disruption of intermolecular bonds that occur when a surface is created. Surfaces are intrinsically less energetically favorable than the bulk of a material (the molecules on the surface have more energy compared with the molecules in the bulk of the material), otherwise there would be a driving force for surfaces to be created, removing the material form the bulk.

Material	γ (J/m2)
Glass	0.37
NaCl	0.40
Al	1.15
MgO	1.20
Si	1.24
Au	1.50
Cu	1.81
Ti	2.00
Ni	2.41
Fe	2.45
Pt	2.48
Со	2.53
Cr	3.32
Cr	3.32

- The surface energy may be defined as the excess energy at the surface of a material compared to the bulk : $\gamma=W/\Delta A$, where W is the reversible work done on a material for increasing its surface area by ΔA

$$\gamma = \frac{W}{\Delta A} = \frac{F\Delta x}{2L\Delta x} \qquad \Delta x$$
excause the

Note: the factor 2 appears because the surface has two sides, bottom and top.

- The surface tension may be defined as the force required to move the side of a particular surface : $\sigma=F/2L$, where F is the force counteracting the surface increase and L is the fixed side of the surface

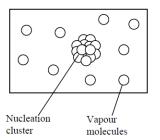
$$\sigma = \frac{F}{2}$$

Notes:

- These formulas apply to a liquid \rightarrow in this case $\gamma = \sigma$
- They are not strictly true for a solid because the work to displace molecules inside the solid that was zero for a fluid must be taken
 into account

Homogeneous nucleation (1)

Homogeneous nucleation of a <u>spherical</u> solid phase of radius *r* from a <u>supersaturated</u> vapor



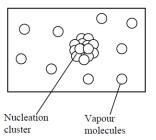
Note: It represents «rare» processes, but it is easy to model because it considers a <u>single chemical species</u>.

It does not consider film growth on a substrate, but nucleation of spheric particles with radius r.

- We assume that the vapor of the compound to be deposited is in a <u>supersaturation</u> condition, i.e. it is characterized by a higher partial pressure (P_V) than the vapor pressure of the compound (P_S) : $P_V > P_S$
 - [The vapor pressure is the pressure, at a given temperature, at which vapor and condensed (solid) phases of the compound are in equilibrium and coexist]
- This situation can be achieved i.e. by reducing the volume and/or increasing the pressure in the deposition chamber, where the compound is contained, to achieve the condition $P_V > P_S$.
- The vapor-to-solid transformation modifies the chemical free energy of the system of $\frac{4}{3}\pi r^3\Delta G_V$
 - $\triangleright \Delta G_V$ is the chemical free energy change per unit volume during the vapor (V \rightarrow S) phase transition
 - $\Rightarrow \frac{4}{3}\pi r^3$ is the volume of the spherical nucleus of radius r nucleated from the vapor phase
 - For the condensation reaction V \rightarrow S, ΔG_V is given by $\Delta G_V = -\frac{k_B T}{\Omega} \ln \frac{P_V}{P_S}$, where T is the temperature above the nucleus (at which P_S is evaluated) and Ω is the atomic volume
 - $P_V > P_S$ for a supersaturated vapor $\implies \Delta G_V < 0 \implies$ nucleation reduces the free energy of the system

Homogeneous nucleation (2)

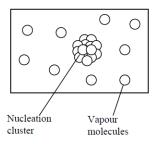
Homogeneous nucleation of a <u>spherical</u> solid phase of radius *r* from a <u>supersaturated</u> vapor



- The gas-to-solid transformation modifies the chemical free energy of the system of $\frac{4}{3}\pi r^3\Delta G_V$
 - $\rightarrow \Delta G_V < 0$ is the chemical free energy change per unit volume \implies the nucleation decreases the chemical free energy of the system
- Simultaneously, new surfaces or interfaces form \implies the surface free energy of the systems increases by $4\pi r^2 \gamma$, where $\gamma > 0$ is the S-V interfacial energy per unit area
- The **total Gibbs free energy change** in forming the nucleus is then $\Delta G = \underbrace{\frac{4}{3}\pi r^3 \Delta G_V}_{\text{Surface/interface}} + \underbrace{\frac{4}{3}\pi r^3 \Delta G_V}_{\text{Surface/interfac$
 - In which conditions the process of nucleation becomes spontaneous ($\Delta G < 0$)?
 - In which conditions a nucleus is in equilibrium ($\Delta G = 0$)?

Homogeneous nucleation (3)

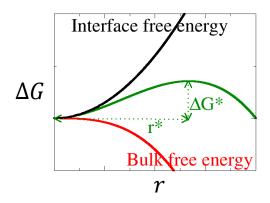
Homogeneous nucleation of a spherical solid phase of radius r from a supersaturated vapor



Looking at the stationary point of ΔG leads to the equilibrium radius size r^* and energy barrier ΔG^* :

oking at the stationary point of
$$\Delta G$$
 leads to the equilibrium radius size r^* and energy barrier ΔG^* :
$$\Delta G = \frac{4}{3}\pi r^3 \Delta G_V + 4\pi r^2 \gamma \implies \frac{d\Delta G}{dr} = 4\pi r^2 \Delta G_V + 8\pi r \gamma = 4\pi r \left(r\Delta G_V + 2\gamma\right) = 0 \implies \begin{cases} r^* = -\frac{2\gamma}{\Delta G_V} & (\Delta G_V < 0) \\ \Delta G^* = \Delta G(r^*) = \frac{16\pi \gamma^3}{3\Delta G_V^2} & (\Delta G_V < 0) \end{cases}$$

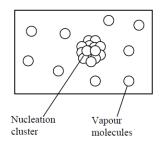
Which is the physical meaning of the energy barrier ΔG^* and the equibrium radius size r^* ?

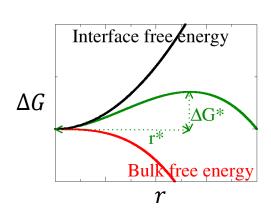


- ΔG^* represents the energy barrier to the nucleation process to be overcome for the nucleation to start
- If a spherical cluster with radius $r < r^*$ forms by thermodynamical fluctuations, it is unstable and will shrink by losing atoms (r decreases for reducing $\Delta G \leftrightarrow$ spontaneous process)
- Clusters with radius $r > r^*$ have overtaken the nucleation energy barrier ΔG^* and are stable. They tend to further grow (r increases for reducing $\Delta G \leftrightarrow$ spontaneous process)

Homogeneous nucleation (4)

Homogeneous nucleation of a <u>spherical</u> solid phase of radius *r* from a <u>supersaturated</u> vapor





Summarizing:

$$\Delta G_V = -\frac{k_B T}{\Omega} \ln \frac{P_V}{P_S} \implies \Delta G_V < 0 \text{ because P}_V > P_S \text{ (supersaturated vapor)}$$

$$r^* = -\frac{2\gamma}{\Delta G_V}$$

$$\Delta G^* = \Delta G(r^*) = \frac{16\pi\gamma^3}{3\Delta G_V^2}$$

$$P_V/P_S$$
 larger \Rightarrow $|\Delta G_V|$ larger \Rightarrow

 P_V/P_S larger $\Rightarrow |\Delta G_V|$ larger \Rightarrow $\int r^*$ smaller \Rightarrow smaller size nuclei to start with, that will remain stable after growing ΔG^* smaller \Rightarrow smaller energy barrier to surmount for the nucleation process to start with r>r*



The <u>formation rate</u> of <u>stable</u> nuclei <u>increases</u> with the P_V/P_S ratio

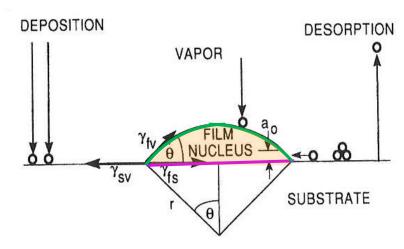
Heterogeneous nucleation (1)

Heterogeneous nucleation of a condensed film on a substrate

- We extend the capillarity theory of <u>homogeneous</u> nucleation (condensation from a vapor phase of a <u>single</u> chemical species used in some CVD processes only) to a condensed film on a substrate → we have:
 - → two species (substrate and depositing material)
 - → two phases (the depositing material is both in solid the film and vapor phases)
 - capillarity theory of heterogeneous nucleation
- Atoms or molecules in the vapor phase impinge on the substrate creating nuclei of mean dimension r.
- The **free-energy change** accompanying the formation of such nuclei is given by

$$\Delta G = a_3 r^3 \Delta G_V + a_1 r^2 \gamma_{fV} + a_2 r^2 \gamma_{fS} - a_2 r^2 \gamma_{SV}$$

- ΔG_V is the chemical free energy change per unit volume (<0) that drives the condensation reaction (as in homogenous nucleation)
- γ are the interfacial energies per unit area between film (f), substrate (S) and vapor (V)
- $a_1 r^2$ is the curved surface area (interface f-V)
- a_2r^2 is the projected area on the substrate (interface f-S)
- $a_3 r^3$ is the film volume



Schematic of basic nucleation processes on substrate during vapor deposition (from M. Ohring, Materials Science of Thin films, Academic Press, Chapter 7)

Heterogeneous nucleation (2)

$$\Delta G = a_3 r^3 \Delta G_V + a_1 r^2 v_{fV} + a_2 r^2 v_{fS} - a_2 r^2 v_{SV}$$

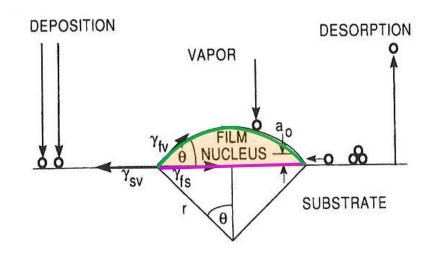
- ΔG_V is the chemical free energy change per unit volume
- γ are the interfacial tensions between film (f), substrate (S) and vapor (V)
- a_1r^2 is the curved surface area (interface f-V)
- a_2r^2 is the projected area on the substrate (interface f-S)
- $a_3 r^3$ is the film volume

For the spherical cap-shaped solid nucleus in figure:

$$a_1 = 2\pi (1 - \cos \theta), a_2 = \pi \sin^2 \theta, a_3 = \pi/3 (2 - 3\cos \theta + \cos^3 \theta)$$

Note: when a new interface appears:

- the surface energy of the film increases
 (+ sign for the first two surface/interface terms, f-V and f-S)
- the **reduction** of the *S-V* interface under the cap implies a reduction in the system energy (- sign for the last interface terms, *S-V*)



Schematic of basic nucleation processes on substrate during vapor deposition (from M. Ohring, Materials Science of Thin films, Academic Press, Chapter 7)

Mechanical equilibrium in the horizontal (parallel to substrate) direction

(in terms of the surface tensions $\sigma = \gamma$)

$$-\gamma_{SV} + \gamma_{fS} + \gamma_{fV} \cos \theta = 0$$



$$\cos\theta = \frac{\gamma_{SV} - \gamma_{fS}}{\gamma_{fV}}$$

The wetting angle θ depends on the material properties (the interface tensions) only

Heterogeneous nucleation (3)

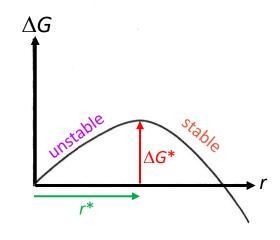
$$\Delta G = a_3 r^3 \Delta G_V + a_1 r^2 \gamma_{fV} + a_2 r^2 \gamma_{fS} - a_2 r^2 \gamma_{SV}$$

Looking at the stationary point of ΔG leads to the critical radius size and free energy barrier:

$$\frac{d\Delta G}{dr} = 3a_3r^2\Delta G_V + 2a_1r\gamma_{fV} + 2a_2r\gamma_{fS} - 2a_2r\gamma_{SV} = r\left(3a_3\Delta G_V r + 2(a_1\gamma_{fV} + a_2\gamma_{fS} - a_2\gamma_{SV})\right) = 0$$

$$r^* = -\frac{2(a_1\gamma_{fV} + a_2\gamma_{fS} - a_2\gamma_{SV})}{3a_3\Delta G_V}$$

$$\Delta G^* = \frac{4(a_1\gamma_{fV} + a_2\gamma_{fS} - a_2\gamma_{SV})^3}{27a_3^2\Delta G_V^2}$$

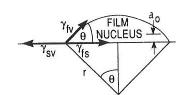


Heterogeneous nucleation behaves as homogeneous nucleation:

- r^* is the critical nucleus size and ΔG^* is the critical free energy barrier for nucleation
- Nuclei are unstable for $r < r^*$ (they disappear by shrinkig, lowering ΔG), and stable for $r > r^*$ (they grow to supercritical dimensions by addition of atoms, lowering ΔG)

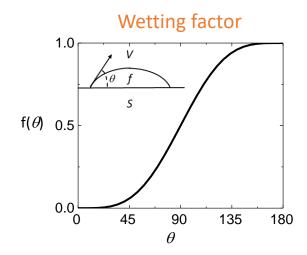
Heterogeneous nucleation (4)

Using the mechanical equilibrium condition parallel to substrate $(-\gamma_{SV} + \gamma_{fS} + \gamma_{fV} \cos \theta = 0)$ and considering the spherical cap-shaded nucleus with wetting angle θ , we calculate the critical free energy barrier ΔG^* as a function of the wetting angle θ :



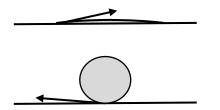
$$\Delta G^* = \frac{4\left(2\pi(1-\cos\theta)\gamma_{fV} + \pi\sin^2\theta\left(\gamma_{fS} - \gamma_{SV}\right)\right)^3}{3\pi^2(2-3\cos\theta+\cos^3\theta)^2\Delta G_V^2} = \frac{4\left(2\pi(1-\cos\theta)\gamma_{fV} - \pi\sin^2\theta\gamma_{fV}\cos\theta\right)^3}{3\pi^2(2-3\cos\theta+\cos^3\theta)^2\Delta G_V^2} = \frac{16\pi\gamma_{fV}^3}{3\Delta G_V^2} \left(2-3\cos\theta+\cos^3\theta\right)^2\Delta G_V^2 + \frac{1}{3\Delta G_V^2} \left(2-3\cos\theta+\cos^3\theta\right)^$$





 $\theta \rightarrow 0 \implies \Delta G^* \rightarrow 0$: when the film **wets** the substrate, there is **no barrier** for nucleation

 $\theta \rightarrow 180^{\circ} \implies \Delta G^* \rightarrow \Delta G^*$ for homogeneous nucleation (of a spherical nucleus)

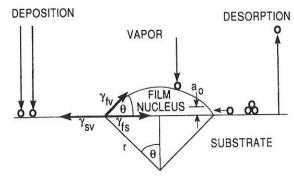


Film growth modes (1)

Mechanical equilibrium in the horizontal (parallel to substrate) direction:

$$-\gamma_{SV} + \gamma_{fS} + \gamma_{fV} \cos \theta = 0 \quad \underline{\text{(Young's equation)}} \quad \Longrightarrow \quad \cos \theta = \frac{\gamma_{SV} - \gamma_{fS}}{\gamma_{fV}}$$

Note: the wetting angle θ depends on the material properties only (the interface tensions γ_{SV} , γ_{fS} , γ_{fV})



Schematic of basic nucleation processes on substrate during vapor deposition (from M. Ohring, Materials Science of Thin films, Academic Press, Chapter 7)

- Island growth:
$$\theta > 0$$
 \Longrightarrow $\cos \theta = \frac{\gamma_{SV} - \gamma_{fS}}{\gamma_{fV}} < 1$ \Longrightarrow $\gamma_{SV} - \gamma_{fS} < \gamma_{fV}$ \Longrightarrow $\gamma_{SV} < \gamma_{fS} + \gamma_{fV}$

Note: if we neglect γ_{fS} , island growth occurs when the surface tension of the film γ_{fV} exceeds that of the substrate $\gamma_{SV} \Rightarrow$ leaving the substrate uncovered leads to energy minimization

E.g.: $\gamma_{fy} = 1.50 \text{ J/m}^2$ for Au, $\gamma_{sy} = 0.86 \text{ J/m}^2$ for GaAs(110) \Rightarrow in general, deposited metals tend to cluster on semiconductor substrates

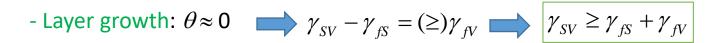
<u>Note</u>: remember that the surface tension in liquids, i.e. the work required to build an area of a particular surface, is equivalent to the surface energy, i.e. the excess energy at the surface of a material compared to the bulk.

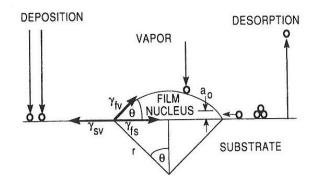
- Layer growth:
$$\theta \approx 0$$
 \Rightarrow $\cos \theta = \frac{\gamma_{SV} - \gamma_{fS}}{\gamma_{fV}} = 1$ \Rightarrow $\gamma_{SV} - \gamma_{fS} = (\geq)\gamma_{fV}$ \Rightarrow $\gamma_{SV} \geq \gamma_{fS} + \gamma_{fV}$

Note: if we neglect γ_{fS} , layer growth occurs when the surface tension of the substrate γ_{SV} exceeds that of the film $\gamma_{fV} \Rightarrow$ covering the substrate with the film leads to energy minimization becase the film-vapor interface is more energetically favourable than the substrate-vapor one.

Film growth modes (2)

- Island growth: θ > 0 \longrightarrow $\gamma_{SV} - \gamma_{fS} < \gamma_{fV} \longrightarrow$ $\gamma_{SV} < \gamma_{fS} + \gamma_{fV}$





<u>Note#1</u>: homo-epitaxy (or auto-epitaxy): $\gamma_{fS} = 0$, $\gamma_{fV} = \gamma_{SV} \Rightarrow$ it is a special case of the layer growth condition in which the interface between film and substrate essentially vanishes



Note#2: consider a superlattice composed of alternating stacked A and B epitaxial films



- if the surface energies γ_{fV} and γ_{SV} are similar (e.g. for semiconductor-semiconductor) the superlattice can be layer-by-layer (we assume to neglect γ_{fS})
- if the surface energies γ_{fV} and γ_{SV} are different (e.g. for metal-metal or metal-semiconductor), layered growth is not guaranteed

Strain contribution to volume

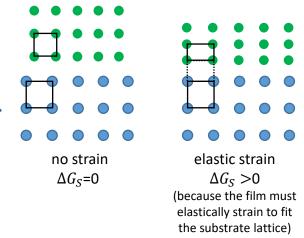
Other energy contributions (e.g. elastic strain) can be «easily» included in the free energy change expression:

$$\Delta G = a_3 r^3 \Delta G_V + a_1 r^2 \gamma_{fV} + a_2 r^2 \gamma_{fS} - a_2 r^2 \gamma_{SV} + a_3 r^3 \Delta G_{SV}$$

 ΔG_{SV} is the <u>strain</u> free energy change per unit volume.

It arises, e.g., from elastic strain of the film because of bonding mismatch between film and substrate

$$\Delta G^* = \frac{4 \left(a_1 \gamma_{fV} + a_2 \gamma_{fS} - a_2 \gamma_{SV}\right)^3}{27 a_3^2 \left(\Delta G_V + \Delta G_{SV}\right)^2} \qquad \text{(instead of } \Delta G^* = \frac{4 \left(a_1 \gamma_{fV} + a_2 \gamma_{fS} - a_2 \gamma_{SV}\right)^3}{27 a_3^2 \Delta G_V^2} \text{)}$$



Note:

- $\Delta G_V < 0 \Rightarrow$ if $\Delta G_{SV} > 0$ (e.g. because an additional energy is needed to *strain the film* fo fit an unmatched substrate lattice) the energy barrier for nucleation ΔG^* will increase and nucleation will be more difficult
- However, if ΔG_{SV} <0 (e.g. because of stress relieval during nucleation of an *initially strained substrate*, e.g. with emergent steps or dislocations) the energy barrier for nucleation ΔG^* will decrease and thus nucleation will be favoured
- ΔG^* could also be affected by substrate charge and impurities, affecting surface and/or volume electrostatic, chemical, etc., energy contributions \Rightarrow they can be treated within the same framework